

714-43-133-31-018000 Information



For Reference Only

Part Number 714-43-133-31-018000

Manufacturer Mill-Max Manufacturing Corp.

Category Connectors, Interconnects

Sockets for ICs, Transistors

Description CONN SOCKET SIP 33POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









714-43-133-31-018000 Specifications

Manufacturer Part Number	714-43-133-31-018000	
Manufacturer	Mill-Max Manufacturing Corp.	
Category	Connectors, Interconnects	
	Sockets for ICs, Transistors	
Package	-	
Series	714	
Туре	SIP	
Number of Positions or Pins (Grid)	33 (1 x 33)	
Pitch - Mating	0.100" (2.54mm)	
Contact Finish - Mating	Gold	
Contact Finish Thickness - Mating	30μin (0.76μm)	
Contact Material - Mating	Beryllium Copper	
Mounting Type	Through Hole	
Features	-	
Termination	Solder	
Pitch - Post	0.100" (2.54mm)	
Contact Finish - Post	Gold	
Contact Finish Thickness - Post	30μin (0.76μm)	
Contact Material - Post	Brass Alloy	
Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Operating Temperature	-55°C ~ 125°C	
		Report errors?

714-43-133-31-018000 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

714-43-133-31-018000 Payment Methods



















714-43-133-31-018000 Shipping Methods













If you have any question about 714-43-133-31-018000, please do not hesitate to contact us!

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